

| STRUCTURE PRODUCTSERIES | Silicon Monolithic Integrated Circuit 2-ch Switching Regulator Controller |
|----------------------------|--|
| TYPE | BD9846FV |
| FEATURES | High Input-voltage (Vcc=35V) MOSFET-driver circuit built-in (d Built-in circuits for error amplifier |

- dual circuit for step-down output)
- reference voltage amp
- (ch1:eternal regulation is possible , ch2:1.0 V \pm 1%)
- Over current detection circuit built-in.
- · Soft-start timing adjustable

OAbsolute maximum ratings (Ta=25°C)

| Item | Symbol | Limits | Unit |
|------------------------------|--------|-------------------|------|
| Power Supply Voltage | Vcc | 36 | V |
| Power dissipation | Pd | 812* ¹ | mW |
| Output pin voltage | Vout | Vcc-7V~Vcc | V |
| C5V pin voltage | VC5V | Vcc-7V~Vcc | V |
| Operating temperature | Topr | -40~+105 | °C |
| Storage temperature | Tstg | -55~+150 | °C |
| Maximum Junction temperature | Tjmax | 150 | °C |

*1 Should be deleted by 6.5mW/°C at Ta=25°C or more. When mounted on a glass epoxy PCB of 70.0mm × 70.0 mm × 1.6 mm ORecommended operating range (Ta=25°C)

| Item | Symbol | Min. | Тур. | Max. | Unit |
|-------------------------------|--------|------|------|------|------|
| Power Supply Voltage | Vcc | 3.6 | 6.0 | 35 | V |
| Output pin voltage | Vout | C5V | - | Vcc | V |
| Error amplifier input voltage | Verrin | 0 | - | 1.6 | V |
| Timing capacitor | Сст | 47 | - | 3000 | pF |
| Oscillation frequency | fosc | 100 | - | 1500 | kHz |
| STB input voltage | VSTB | 0 | - | Vcc | V |

OElectrical characteristics (Unless otherwise specified, Ta=25°C, VCC=6V)

| | | | Limits | | | |
|---------------------|-----------|------|--------|------|------|--------------------|
| Item | Symbol | Min. | Тур. | Max | Unit | Conditions |
| [VREF output block] | | | | | | |
| VREF output voltage | Vref | 2.47 | 2.50 | 2.52 | V | lo=0.1mA |
| Line regulation | Line reg. | _ | 1 | 10 | mV | Vcc=3.6V→35V |
| Load regulation | Load reg. | _ | 2 | 10 | mV | lo=0.1mA→2mA |
| Output max. current | IOMAX | 2 | 13 | _ | mA | VREF=(typ.) * 0.95 |



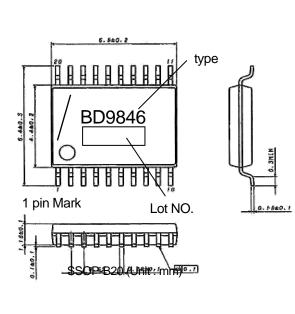
| Item | Symbol | | limits | 1 | Unit | Conditions |
|--|-----------|------|--------|------|------|-----------------------------------|
| | Cymbol | Min. | Тур. | Max. | 01 | |
| [Triangular wave oscillator block] | fooo | 05 | 100 | 117 | | Cor. 1800pF |
| Oscillation frequency | fosc | 95 | 106 | 117 | kHz | Ccp=1800pF |
| Frequency variation | fDV | _ | 0 | 1 | % | Vcc=3.6V→35V |
| [Soft-start block] | | | | | | 00.051/ |
| SS pin source current | Issso | 1.4 | 2 | 2.6 | μA | SS=0.5V |
| SS pin sink current | ISSSI | 5 | 12 | — | mA | SS=0.5V |
| [Dead time adjustable circuit block] | · . | | | | | |
| DT pin input bias current | IDT | | 0.1 | 1 | μA | DT=1.75V |
| DT pin sink current | IDTSI | 1 | 3.3 | | mA | DT=1.75V, (OCP+)-(OCP-)=0.5V |
| [UVLO block] | | | | | | |
| Threshold voltage | Vuth | 3.0 | 3.2 | 3.4 | V | Vcc when rise time |
| Hysterisis | VUHYS | — | 0.15 | 0.25 | V | |
| [Error Amp block] | r | | 1 | 1 | [| |
| NON input bias current (ch1) | Inon | _ | 0 | 1 | μA | NON=1V |
| Non-Inverting input reference voltage(ch2) | Vinv | 0.99 | 1 | 1.01 | V | INV=FB |
| Reference voltage variation (ch2) | dVinv | _ | 1 | 6 | mV | Vcc=3.6V→35V |
| INV input bias current | lів | | 0 | 1 | μA | INV=1V |
| Open loop gain | AV | 70 | 85 | — | dB | |
| Output FB voltage (Hi) | Vfbh | 2.30 | — | VREF | V | |
| Output FB voltage (Low) | VFBL | — | 0.6 | 1.3 | V | |
| Output sink current | IFBSI | 0.5 | 1.5 | — | mA | FB=1.25V , INV=1.5V |
| Output source current | IFBSO | 50 | 105 | — | μA | FB=1.25V , INV=0V |
| [PWM comparator] | | | | | | |
| Input threshold voltage | Vto | 1.4 | 1.5 | 1.6 | V | On duty 0% |
| (fosc=100kHz) | Vt100 | 1.9 | 2 | 2.1 | V | On duty 100% |
| [Output block] | | | | | | |
| Output ON resistance H | Ronh | - | 4 | 10 | Ω | RONH=(VCC -OUT)/ lout, lout=0.1A |
| Output ON resistance L | Ronl | _ | 3.3 | 10 | Ω | RONL=(OUT-C5V)/ lout, lout=0.1A |
| C5V clamp voltage | VCLMP | 4.5 | 5 | 5.5 | V | VCLMP= VCC-C5V , VCC >7V |
| [Over current protection circuit (O | CP) block |] | | | | |
| OCP threshold voltage | VOCPTH | 0.04 | 0.05 | 0.06 | V | Voltage between (OCP+)-(OCP-) |
| OCP-input bias current | IOCP- | 1 | 0.1 | 10 | μA | OCP+= Vcc, OCP-= Vcc-0.05V |
| Delay time for OCP | tdocpth | _ | 200 | 400 | nS | OCP-= Vcc→Vcc-0.2V |
| Min. hold time for OCP | tdocpre | 0.8 | 1.6 | _ | mS | OCP-= Vcc-0.2V→Vcc |
| [Stand-by switch block] | 1 | | | | | • |
| Threshold voltage for each CH stop | VDTthL | 1.1 | 1.25 | 1.4 | V | DT Pin H/L |
| Stand-by mode setting voltage range | VSTBL | 0 | _ | 0.5 | V | |
| Active setting voltage range | VSTBH | 3 | _ | Vcc | V | |
| STB current | Іsтв | | 70 | 100 | μA | STB=6V |
| [Total device] | | | | | , · | - |
| Stand-by current | Iccs | | 0 | 1 | μA | STB=0V |
| Average current consumption | ICCA | 1.5 | 3 | 6 | mA | INV=0V, FB=H, DT=1.75V |

OElectrical characteristics (Unless otherwise specified, Ta=25°C, VCC=6V)

 \times Not designed for radiation resistance.



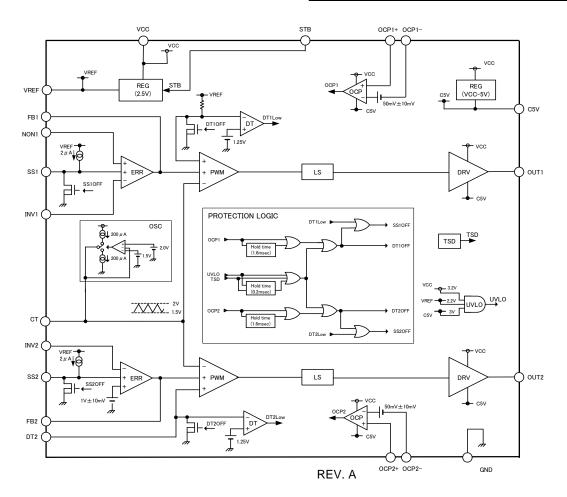
OOutline figure



OPIN No./ name / function

| Pin No. | Pin name | Pin function |
|------------|----------|--|
| 1 | CT | External Capacitor pin for timing change |
| 2 | DT2 | Dead time setting (CH2) |
| 3 | SS2 | Soft-start time setting (CH2) |
| 4 | INV2 | Error Amp inverting input (CH2) |
| 5 | FB2 | Error Amp output (CH2) |
| 6 | GND | GROUND |
| 7 | OCP2- | Over current error amp inverting input (CH2) |
| 8 | OCP2+ | Over current error amp input (CH2) |
| 9 | C5V | Output L voltage (Vcc-5V) |
| 10 | OUT2 | CH2 Output |
| 11 | OUT1 | CH1 Output |
| 12 | Vcc | Power supply input |
| 13 | OCP1+ | Over current error amp input (CH1) |
| 14 | OCP1- | Over current error amp inverting input (CH1) |
| 15 | STB | Stand-by mode control |
| 16 | FB1 | Error Amp output (CH1) |
| 17 | INV1 | Error Amp inverting input (CH1) |
| 18 | SS1 | Soft-start time setting (CH1) |
| 19 | NON1 | Error Amp input (CH1) |
| 20 | VREF | Reference voltage (2.5V) output |

OBlock Diagram





Operation Notes

1) Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings such as the applied voltage or operating temperature range may result in IC deterioration or damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure such as a fuse should be implemented when use of the IC in a special mode where the absolute maximum ratings may be exceeded is anticipated.

2) GND potential

Ensure a minimum GND pin potential in all operating conditions. In addition, ensure that no pins other than the GND pin carry a voltage lower than or equal to the GND pin, including during actual transient phenomena.

3) Thermal design

Use a thermal design that allows for a sufficient margin in light of the power dissipation (Pd) in actual operating conditions.

4) Inter-pin shorts and mounting errors

Use caution when orienting and positioning the IC for mounting on printed circuit boards. Improper mounting may result in damage to the IC. Shorts between output pins or between output pins and the power supply and GND pin caused by the presence of a foreign object may result in damage to the IC.

5) Operation in a strong electromagnetic field

Use caution when using the IC in the presence of a strong electromagnetic field as doing so may cause the IC to malfunction.

6) Thermal shutdown circuit (TSD circuit)

This IC incorporates a built-in thermal shutdown circuit (TSD circuit). The TSD circuit is designed only to shut the IC off to prevent runaway thermal operation. Do not continue to use the IC after operating this circuit or use the IC in an environment where the operation of the thermal shutdown circuit is assumed.

7) Testing on application boards

When testing the IC on an application board, connecting a capacitor to a pin with low impedance subjects the IC to stress. Always discharge capacitors after each process or step. Ground the IC during assembly steps as an antistatic measure, and use similar caution when transporting or storing the IC. Always turn the IC's power supply off before connecting it to or removing it from a jig or fixture during the inspection process.

8) Common impedance

Power supply and ground wiring should reflect consideration of the need to lower common impedance and minimize ripple as much as possible (by making wiring as short and thick as possible or rejecting ripple by incorporating inductance and capacitance).

9) Applications with modes that reverse VCC and pin potentials may cause damage to internal IC circuits.

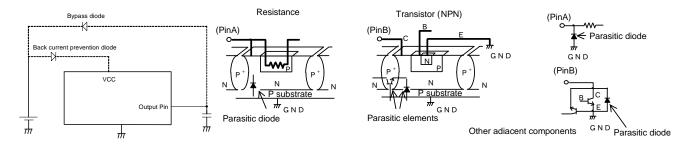
For example, such damage might occur when VCC is shorted with the GND pin while an external capacitor is charged. It is recommended to insert a diode for preventing back current flow in series with VCC or bypass diodes between VCC and each pin.

10) IC pin input

This monolithic IC contains P+ isolation and PCB layers between adjacent elements in order to keep them isolated.

- P/N junctions are formed at the intersection of these P layers with the N layers of other elements to create a variety of parasitic elements. For example, when a resistor and transistor are connected to pins as shown in Fig. 10,
 - O The P/N junction functions as a parasitic diode when GND > (Pin A) for the resistor or GND > (Pin B) for the transistor (NPN).
 O Similarly, when GND > (Pin B) for the transistor (NPN), the parasitic diode described above combines with the N layer of other adjacent elements to operate as a parasitic NPN transistor.

The formation of parasitic elements as a result of the relationships of the potentials of different pins is an inevitable result of the IC's architecture. The operation of parasitic elements can cause interference with circuit operation as well as IC malfunction and damage. For these reasons, it is necessary to use caution so that the IC is not used in a way that will trigger the operation of parasitic elements, such as by the application of voltages lower than the GND (PCB) voltage to input and output pins.



| | Notes |
|---|---|
| | g or reproduction of this document, in part or in whole, is permitted without the ROHM Co.,Ltd. |
| The conten | t specified herein is subject to change for improvement without notice. |
| "Products") | It specified herein is for the purpose of introducing ROHM's products (hereinafte b. If you wish to use any such Product, please be sure to refer to the specifications be obtained from ROHM upon request. |
| illustrate th | of application circuits, circuit constants and any other information contained herein e standard usage and operations of the Products. The peripheral conditions mus to account when designing circuits for mass production. |
| However, s | was taken in ensuring the accuracy of the information specified in this document should you incur any damage arising from any inaccuracy or misprint of such , ROHM shall bear no responsibility for such damage. |
| examples of implicitly, a other partie | cal information specified herein is intended only to show the typical functions of and of application circuits for the Products. ROHM does not grant you, explicitly o ny license to use or exercise intellectual property or other rights held by ROHM and es. ROHM shall bear no responsibility whatsoever for any dispute arising from the technical information. |
| equipment | ets specified in this document are intended to be used with general-use electronic or devices (such as audio visual equipment, office-automation equipment, commu vices, electronic appliances and amusement devices). |
| The Produc | ts specified in this document are not designed to be radiation tolerant. |
| | M always makes efforts to enhance the quality and reliability of its Products, a ay fail or malfunction for a variety of reasons. |
| against the failure of ar shall bear r | sure to implement in your equipment using the Products safety measures to guard possibility of physical injury, fire or any other damage caused in the event of the product, such as derating, redundancy, fire control and fail-safe designs. ROHM responsibility whatsoever for your use of any Product outside of the prescribed of in accordance with the instruction manual. |
| system whi may result instrument fuel-contro any of the F | cts are not designed or manufactured to be used with any equipment, device or ch requires an extremely high level of reliability the failure or malfunction of which in a direct threat to human life or create a risk of human injury (such as a medica , transportation equipment, aerospace machinery, nuclear-reactor controller ller or other safety device). ROHM shall bear no responsibility in any way for use of Products for the above special purposes. If a Product is intended to be used for any al purpose, please contact a ROHM sales representative before purchasing. |
| be controlle | d to export or ship overseas any Product or technology specified herein that may ed under the Foreign Exchange and the Foreign Trade Law, you will be required to ense or permit under the Law. |



Thank you for your accessing to ROHM product informations. More detail product informations and catalogs are available, please contact us.

ROHM Customer Support System

http://www.rohm.com/contact/

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ROHM Semiconductor: BD9846FV-E2